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Resistive switching in nanostructured thin films

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Planar capacitor structures based on granular films composed of nanometric ferromagnetic grains embedded in an insulating Al2O3 matrix can switch between a high-conductance and a low-conductance state. The switching properties are induced by a forming process. The ON/OFF resistance ratio is as high as 10^4 under an electrical field of only 15 kV/m. This resistive switching is accompanied by a capacitive switching between two well-defined voltage-independent states, a behavior that is not readily explained by the filamentary type of conduction. © 2009 American Institute of Physics. [DOI: 10.1063/1.3134484]

Nanometer-scale magnetic materials are gaining widespread interest because of interesting effects arising from the reduction of their size. Among these, structures consisting of magnetic single-domain nanoparticles are a class of granular magnetoresistive films interesting for magnetic sensors and magnetic single-domain nanoparticles are a class of granular reduction of their size. Among these, structures consisting of nanometric ferromagnetic grains embedded in an insulating Al2O3 matrix can switch between a high-conductance and a low-conductance state. The switching properties are induced by a forming process. The ON/OFF resistance ratio is as high as 10^4 under an electrical field of only 15 kV/m. This resistive switching is accompanied by a capacitive switching between two well-defined voltage-independent states, a behavior that is not readily explained by the filamentary type of conduction. © 2009 American Institute of Physics. [DOI: 10.1063/1.3134484]

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bias. When the scanning voltage range was increased up to 30 V, the negative-bias region kept its normal behavior; however, in the return scan of the positive-bias sweep, an irregular behavior was observed. The current became very noisy and its average value is independent of voltage in the range of 30–10 V. Then, at 10 V, a switching event occurred which increased the current more than two orders of magnitude. After the switching to a high-conductive state, the noise in current also disappeared. The device $I$-$V$ characteristics are now permanently modified and exhibit the behavior shown in Fig. 2. This change in the behavior after a stressing voltage is known as “forming” and is commonly reported for other memory devices. According to the literature, this forming step involves the generation of oxygen-related defects by the high electric field. These defects can then be programmed by a voltage pulse and thus leads to a memory device.

Once the device is formed, the $I$-$V$ characteristics can be programmed from a typical OFF state to an ON state. The ON-state up-scanning curve has a sudden downward jump at around 10 V, followed by a noisy behavior. This type of $I$-$V$ characteristics resembles very much the negative differential resistance characteristics reported in the literature for other memory devices. Reliable switching is now obtained by a voltage pulse below and above the sharp drop in current at the critical voltage of 10 V. For instance, switching from the low-conductive state to the high-conductive state is achieved by applying a voltage that is lower than 10 V. On the other hand, a voltage pulse above the threshold voltage of 10 V must be applied to reset the device to the low-conductive state. This type of switching behavior is typical of many insulating oxides.

The ON and OFF states are stable for periods of several days. It is possible that these retention times are even longer, but no detailed studies have been conducted, yet. However, in one of our devices we encountered an additional effect that might shine some light on the way the device functions. After many cycles between the ON and OFF states, the low-voltage range shows a different behavior, as shown in Fig. 3(a). Most interestingly, the switching to the ON state occurs now for lower biases. This type of switching is highly reproducible.

FIG. 2. (a) Current-voltage ($I$-$V$) plots showing a sudden and irreversible change (forming process). In the positive-bias return-voltage scan, the current becomes noisy and switches between a low-conductive and a high-conductive state at around 10 V. (b) $I$-$V$ characteristics of a device obtained after forming.

FIG. 3. (a) Low-bias region of the final bistable current-voltage characteristics observed after many ON/OFF cycles. (b) Step change in capacitance accompanying the resistive switching ($f=1$ kHz). (c) Multiple capacitance jumps between two discrete states occurring at a constant voltage.
ducible, occurring always at exactly the same bias ($V = 1.5 \text{ V}$). However, the retention time of the ON state is in a time scale of 1–3 min, and the device thus no longer behaves as nonvolatile memory.

Switching was also studied using small-signal impedance measurements. It was observed that resistive switching is accompanied by a single step change in a capacitance of 14 pF, as shown in Fig. 3(b). This change between two voltage-independent capacitance states indicates that there are only two discrete states of the sample. When scanning the voltage slowly, it is possible to observe a series of capacitance jumps between the low-capacitance and the high-capacitance state. These transitions are always located in a narrow voltage range, which coincides with the voltage where resistive switching occurs [see Fig. 3(c)].

Resistive switching is often attributed to the formation of filaments across the sample.\textsuperscript{3,15} Indeed filaments have been observed in lateral structures of SrTiO$_3$ using local conducting atomic microscopy.\textsuperscript{15} The authors proposed that a network of dislocations forms during the electroforming step, and filling and emptying of the dislocations with oxygen ions correspond to the OFF and ON switching. However, the observation here that the capacitance switches are systematically between well-defined initial and final values, even after repeated switching as shown in Fig. 3(c), seems counterintuitive in a filamentary type of conduction. It is implausible that for every switching event, the same exact number of identical filaments is formed. Also note that a single filament would be unable to carry the current observed (0.1 mA). Therefore, this observation of discrete capacitance states cannot be simply explained by a discrete filamentary type of conduction. We suggest that the increase in capacitance is caused by a trapping mechanism and an associated charge accumulation, which decreases the effective distance between the electrodes. Charges can be trapped in a matrix of defects that can be formed by the metallic grains. Once the traps are filled, charge neutrality must be maintained with opposite charges in their vicinity. If these compensating charges are mobile and located in the $\text{Al}_2\text{O}_3$ matrix, they will increase the free carrier density and allow for much higher conductivity of the oxide. These charge accumulating regions surrounding the defects can grow and expand. Eventually, neighboring regions can merge together. When this occurs the effective distance between the electrodes is decreased and the internal electric field increases, thus accelerating the merging of these regions until charge carriers can easily travel from one electrode to another. The layer with nanoparticles becomes a conductive sheet, and the capacitance approximates that of two parallel plate capacitors, easily traveled from one electrode to another. The layer with nanoparticles becomes a conductive sheet, and the capacitance approximates that of two parallel plate capacitors.

In conclusion, planar-type capacitor device structures, consisting of ferromagnetic grains embedded in an insulating $\text{Al}_2\text{O}_3$ matrix, show a memory-type resistive-switching effect. The device has a large dynamic range of the resistance change. Most interestingly, the threshold voltage for switching is highly reproducible and corresponds to a weak programming field (15 kV/m), making these devices compatible with complementary metal-oxide semiconductor technology, an advantage for a realistic commercial device application. The discrete nature of capacitance switching presented here provides interesting information. While it is becoming accepted that switching is due to the establishment of discrete conducting filaments, the present results strongly suggest that, upon switching, there is also a charge trapping process in the device that causes a dramatic increase in the overall device capacitance. It is important to elucidate the role of these charges in the microscopic mechanism involved in the resistive switching.

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\begin{figure}[h]
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\includegraphics[width=0.5\textwidth]{fig4.png}
\caption{(Color online) Phenomenological model to explain the formation of a network of conducting paths across the sample.}
\end{figure}

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